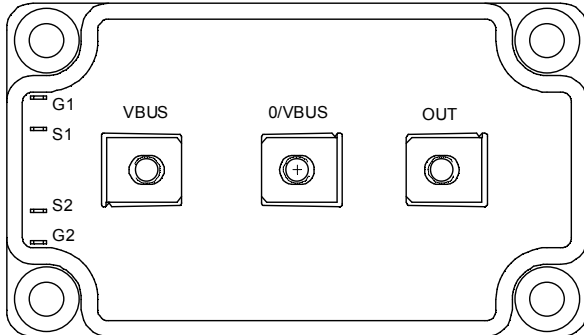
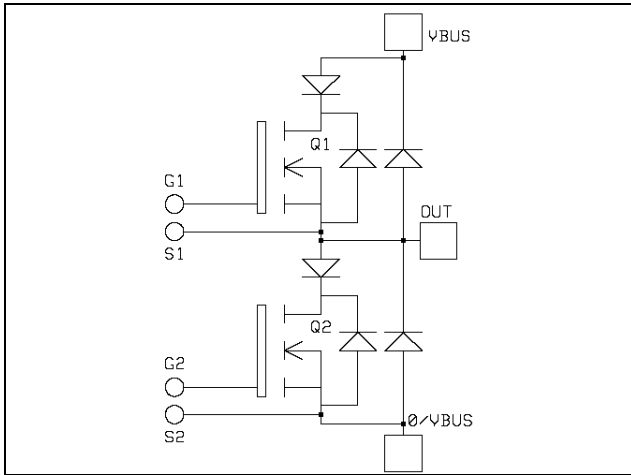


*Phase leg
Series & SiC parallel diodes
Super Junction
MOSFET Power Module*

$V_{DSS} = 800V$
 $R_{DSon} = 75m\Omega \text{ max @ } T_j = 25^\circ C$
 $I_D = 56A \text{ @ } T_c = 25^\circ C$



Application

- Motor control
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

Features



- Ultra low R_{DSon}
- Low Miller capacitance
- Ultra low gate charge
- Avalanche energy rated
- **Parallel SiC Schottky Diode**
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature Independent switching behavior
 - Positive temperature coefficient on VF
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
 - M5 power connectors
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V_{DSS}	Drain - Source Breakdown Voltage	800	V
I_D	Continuous Drain Current	$T_c = 25^\circ C$	56
		$T_c = 80^\circ C$	43
I_{DM}	Pulsed Drain current	232	
V_{GS}	Gate - Source Voltage	± 30	V
R_{DSon}	Drain - Source ON Resistance	75	$m\Omega$
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$	568
I_{AR}	Avalanche current (repetitive and non repetitive)	24	A
E_{AR}	Repetitive Avalanche Energy	0.5	mJ
E_{AS}	Single Pulse Avalanche Energy	670	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
BV_{DSS}	Drain - Source Breakdown Voltage	$V_{GS} = 0V, I_D = 1000\mu A$	800			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 800V, T_j = 25^\circ\text{C}$			100	μA
		$V_{GS} = 0V, V_{DS} = 800V, T_j = 125^\circ\text{C}$			1000	
$R_{DS(on)}$	Drain - Source on Resistance	$V_{GS} = 10V, I_D = 28A$			75	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 4mA$	2.1	3	3.9	V
I_{GSS}	Gate - Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 200	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0V$		9015		pF
C_{oss}	Output Capacitance	$V_{DS} = 25V$		4183		
C_{rss}	Reverse Transfer Capacitance	$f = 1MHz$		215		
Q_g	Total gate Charge	$V_{GS} = 10V$		364		nC
Q_{gs}	Gate - Source Charge	$V_{Bus} = 400V$		48		
Q_{gd}	Gate - Drain Charge	$I_D = 56A$		184		
$T_{d(on)}$	Turn-on Delay Time	Inductive switching @ 125°C $V_{GS} = 15V$ $V_{Bus} = 553V$ $I_D = 56A$ $R_G = 1.2\Omega$		10		ns
T_r	Rise Time			13		
$T_{d(off)}$	Turn-off Delay Time			83		
T_f	Fall Time			35		
E_{on}	Turn-on Switching Energy	Inductive switching @ 25°C $V_{GS} = 15V, V_{Bus} = 533V$ $I_D = 56A, R_G = 1.2\Omega$		583		μJ
E_{off}	Turn-off Switching Energy ①			556		
E_{on}	Turn-on Switching Energy	Inductive switching @ 125°C $V_{GS} = 15V, V_{Bus} = 533V$ $I_D = 56A, R_G = 1.2\Omega$		1020		μJ
E_{off}	Turn-off Switching Energy ①			684		

Series diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle, $T_c = 85^\circ\text{C}$		60		A
V_F	Diode Forward Voltage	$I_F = 60A$		1.1	1.15	V
		$I_F = 120A$		1.4		
		$I_F = 60A, T_j = 125^\circ\text{C}$		0.9		
t_{rr}	Reverse Recovery Time	$I_F = 60A, V_R = 133V, di/dt = 400A/\mu s, T_j = 25^\circ\text{C}$		24		ns
		$T_j = 125^\circ\text{C}$		48		
Q_{rr}	Reverse Recovery Charge	$I_F = 60A, V_R = 133V, di/dt = 400A/\mu s, T_j = 25^\circ\text{C}$		66		nC
		$T_j = 125^\circ\text{C}$		300		

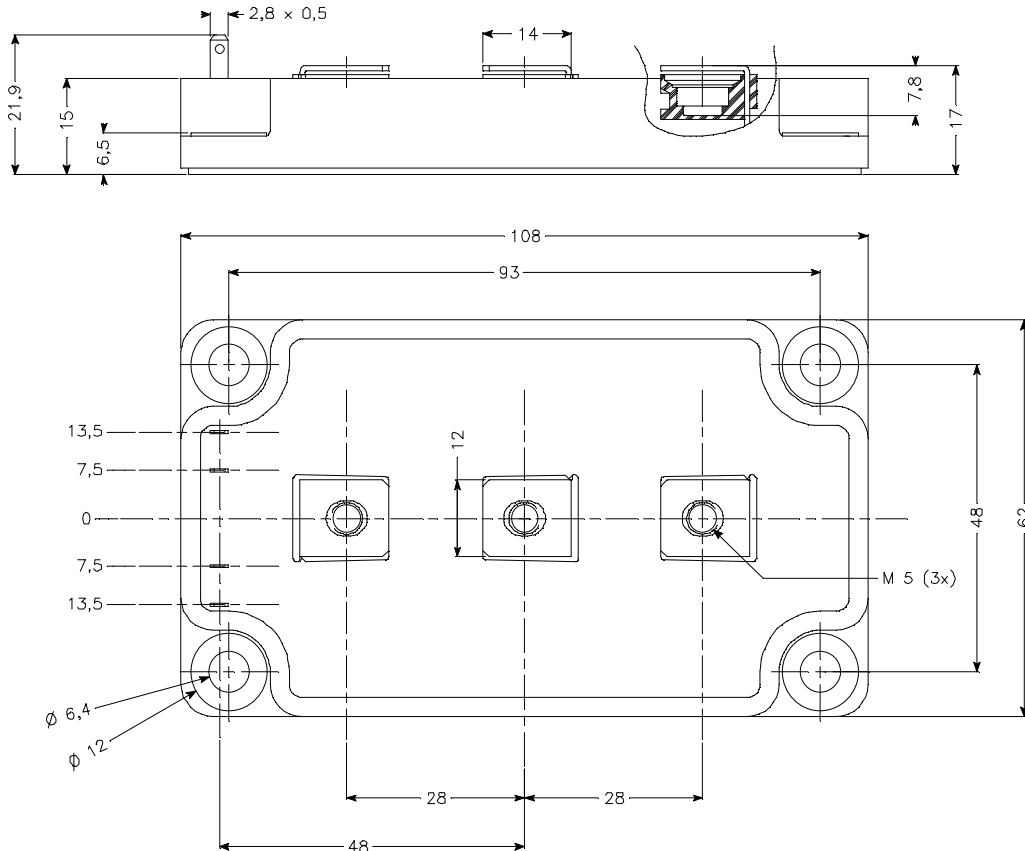
Parallel diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle $T_c = 125^\circ\text{C}$		30		A
V_F	Diode Forward Voltage	$I_F = 30\text{A}$	$T_j = 25^\circ\text{C}$	1.6	1.8	V
			$T_j = 175^\circ\text{C}$	2.6	3.0	
Q_C	Total Capacitive Charge	$I_F = 30\text{A}, V_R = 600\text{V}$ $di/dt = 1600\text{A}/\mu\text{s}$		84		nC
Q	Total Capacitance	$f = 1\text{MHz}, V_R = 200\text{V}$		270		pF
		$f = 1\text{MHz}, V_R = 400\text{V}$		198		

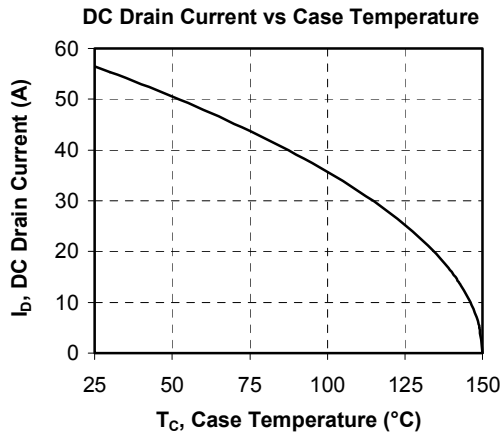
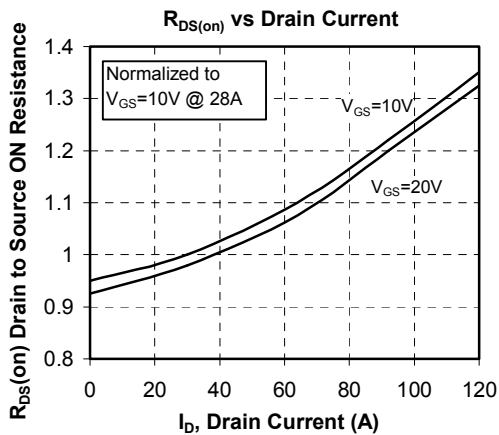
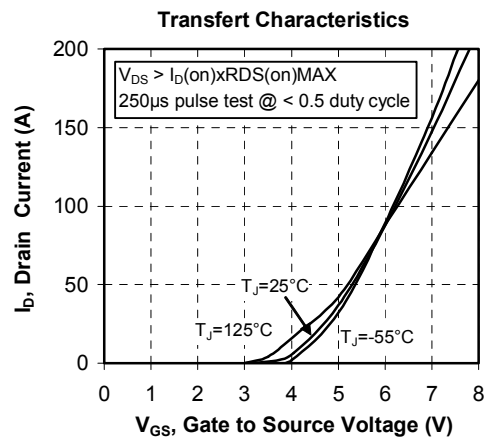
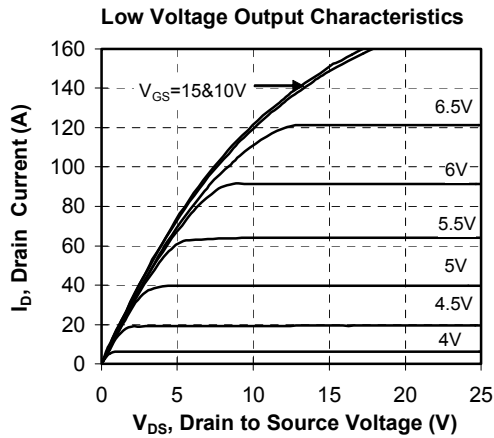
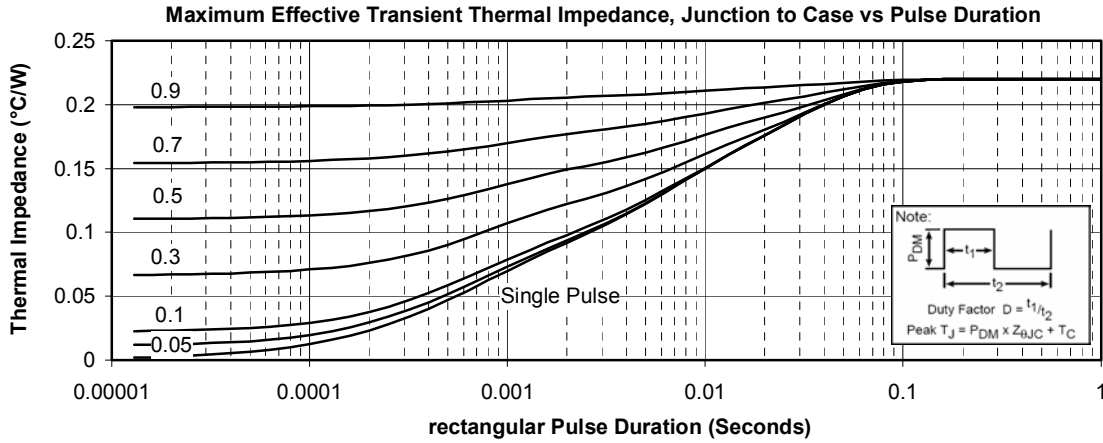
Thermal and package characteristics

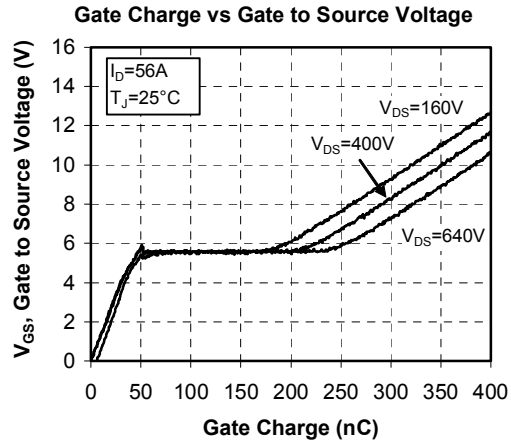
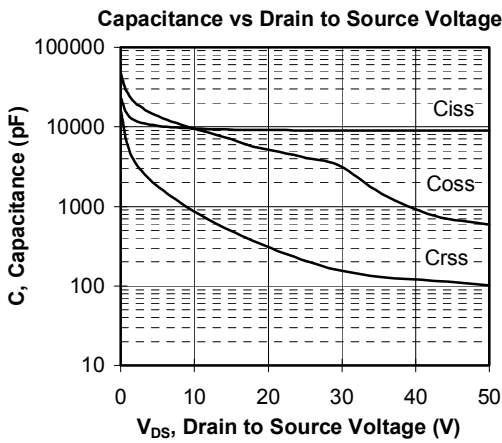
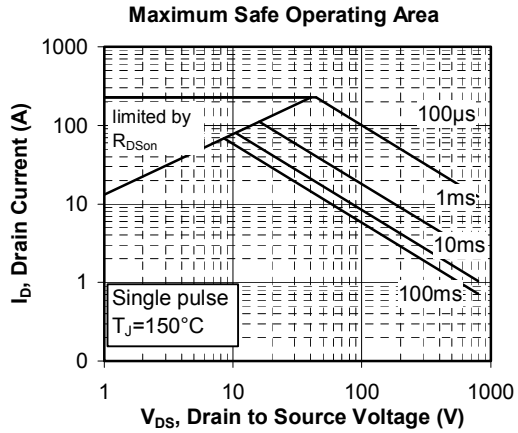
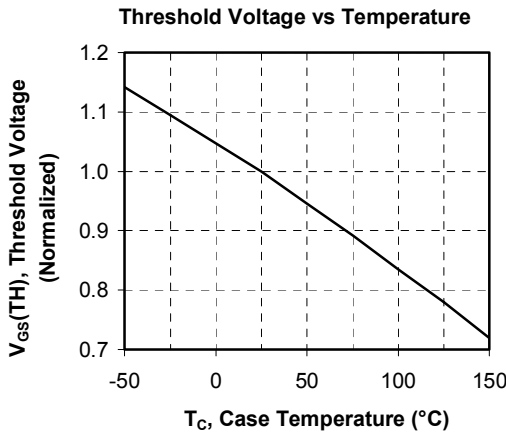
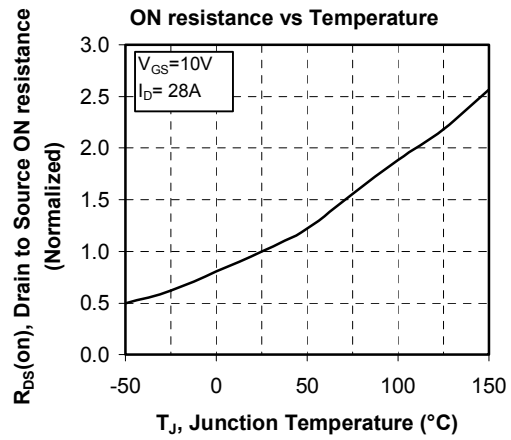
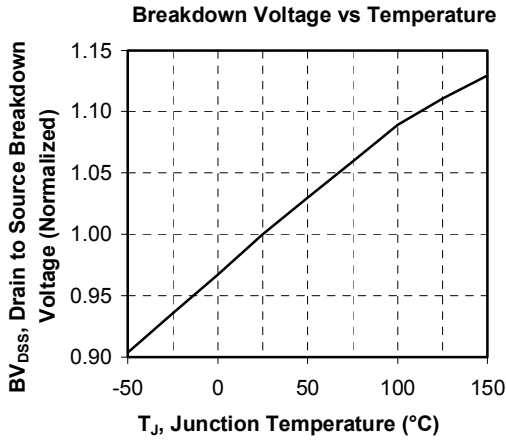
Symbol	Characteristic	Min	Typ	Max	Unit	
R_{thJC}	Junction to Case	Transistor		0.22	$^\circ\text{C}/\text{W}$	
		Series diode		0.65		
		Parallel diode		0.45		
V_{ISOL}	RMS Isolation Voltage, any terminal to case $t = 1\text{ min}, I_{isol} < 1\text{mA}, 50/60\text{Hz}$	2500			V	
T_J	Operating junction temperature range	-40		150	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-40		125		
T_C	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink	M6	3	5	N.m
		For terminals	M5	2	3.5	
Wt	Package Weight			280	g	

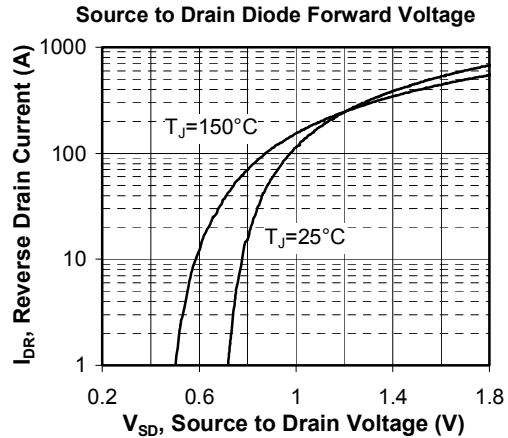
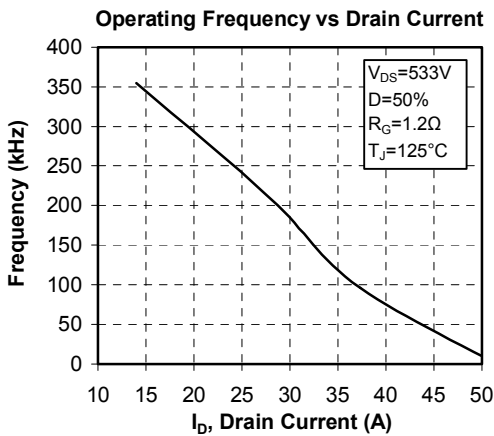
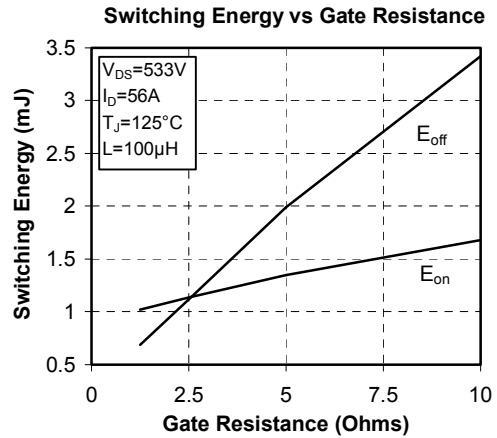
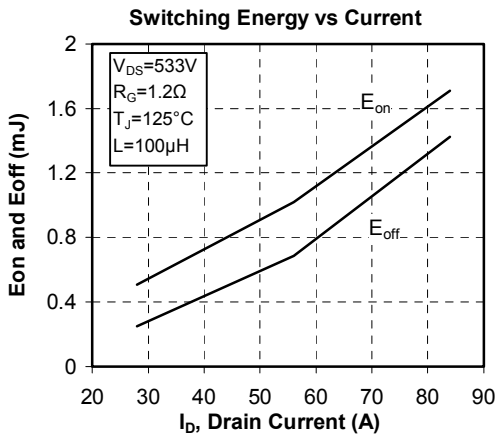
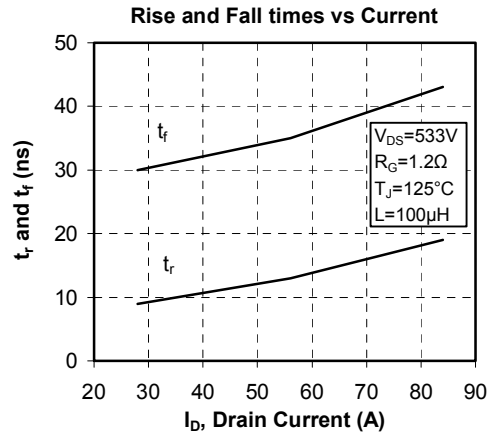
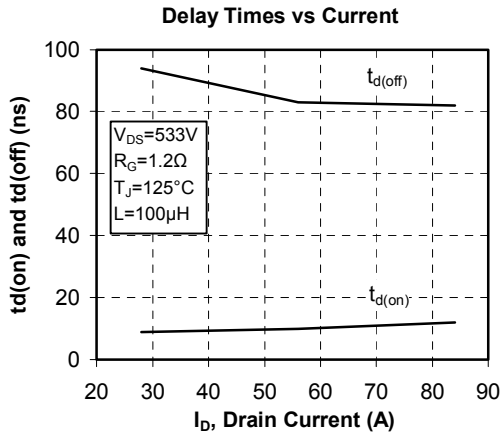
Package outline



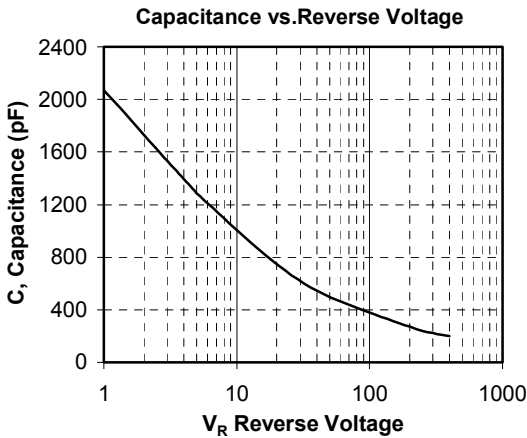
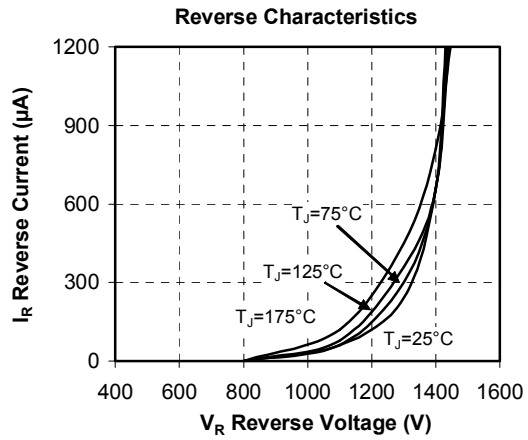
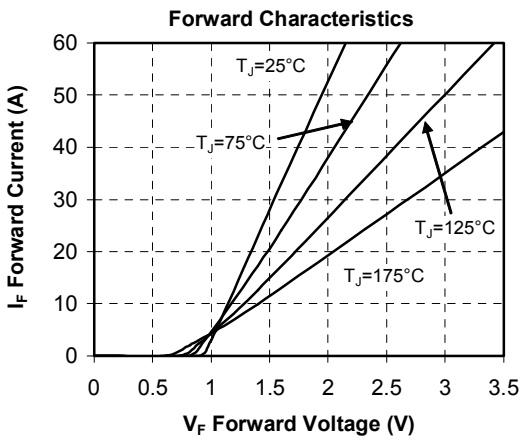
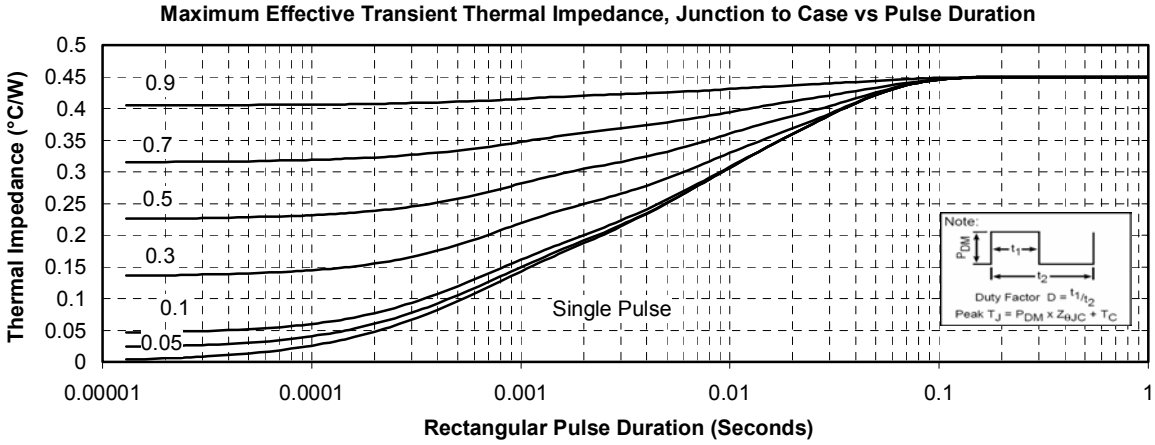
Typical CoolMOS Performance Curve







Typical SiC Diode Performance Curve



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APT's products are covered by one or more of U.S patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S and Foreign patents pending. All Rights Reserved.